

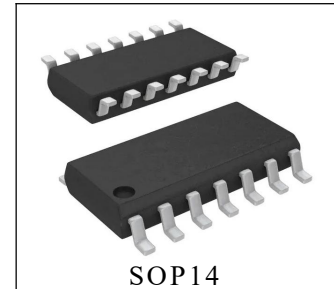
# TS04

## 4-CH Auto Sensitivity Calibration Capacitive Touch Sensor

### General Description

The TS04 is a monolithic IC which has high performance capacitive touch sensor with self calibration function.

The TS04 is available in standard SOP14 package.



### Features

- 4-Channel Capacitive Sensor with Auto Sensitivity Calibration
- Parallel Output Interface
- Independently Adjustable Sensitivity with External Capacitor
- Adjustable Internal Frequency with External Resister
- Embedded High Frequency Noise Elimination Circuit
- Low Current Consumption

### Package Information

Part NO.	Package Description	Package Marking	Package Option
TS04	SOP14	CHMC SXXXX TS04	50/Tube 4000/Reel

CHMC: Trademark

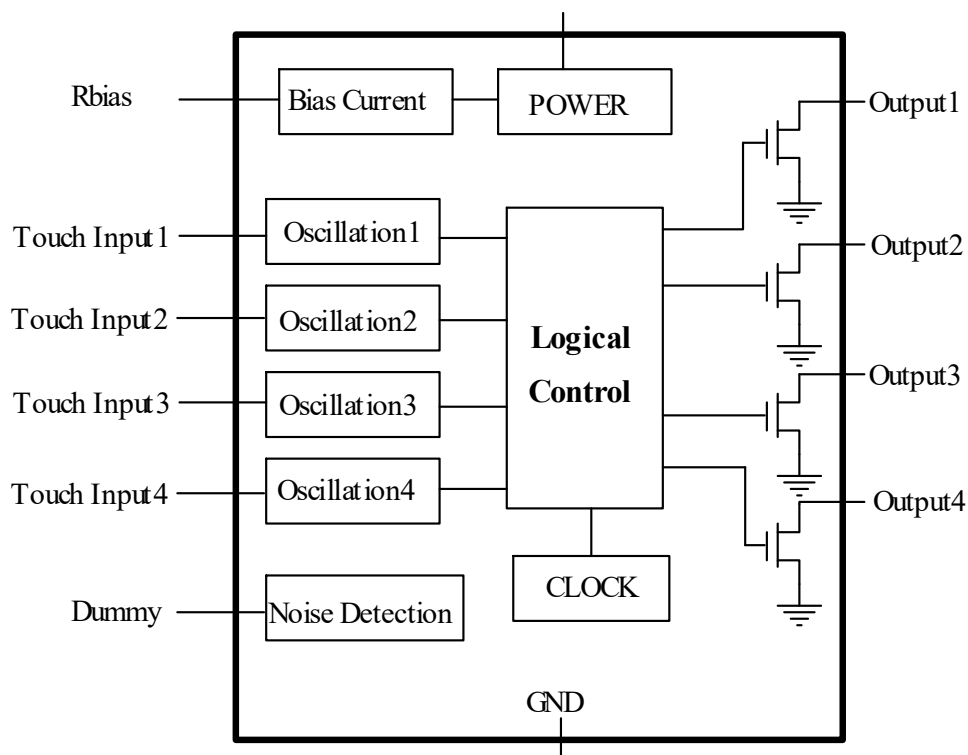
TS04:Part NO.

SXXXX:Lot NO.

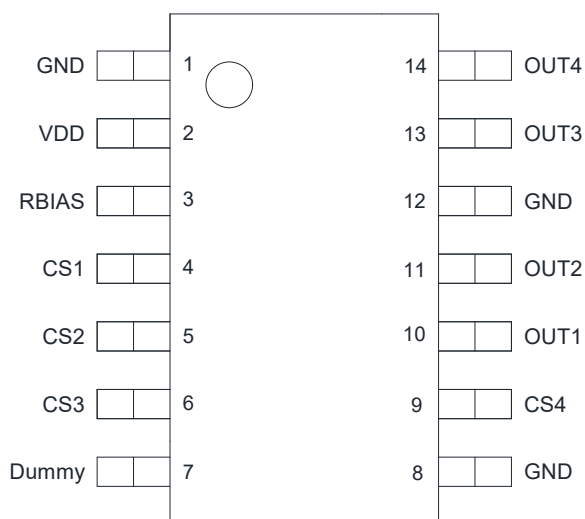
### Applications

- Mobile Application (Mobile Phone / PDA / PMP / MP3 etc)
- Membrane Switch Replacement
- Sealed Control Panels, Keypads
- Door Key-Lock Matrix Application

## Functional Block Diagram



## Pin Configuration



**TS04(SOP14)**

## Pin Description

Pin Number	Pin Name	Function Description
1	GND	Connect to GND
2	VDD	Power (2.5V~5.0V)
3	RBIAS	Internal bias adjust input
4	CS1	CH1 capacitive sensor input
5	CS2	CH2 capacitive sensor input
6	CS3	CH3 capacitive sensor input
7	Dummy	Internal noise monitoring input .Do not connect to anywhere
8	GND	Supply ground
9	CS4	CH4 capacitive sensor input
10	OUT1	Output1 for CS1 (open drain structure)
11	OUT2	Output2 for CS2 (open drain structure)
12	GND	Supply ground
13	OUT3	Output3 for CS3 (open drain structure)
14	OUT4	Output4 for CS4 (open drain structure)

## Absolute Maximum Ratings (Ta=25°C)

Parameter Name	Symbol	Value	Unit
Battery Supply Voltage	VDD	5.0	V
Maximum Voltage On Any Pin	V <sub>MAX</sub>	VDD+0.3	V
Maximum Current On Any PAD	I <sub>MAX</sub>	100	mA
Power Dissipation	P <sub>DMAX</sub>	800	mW
Storage Temperature	T <sub>stg</sub>	-50 ~ 150	°C
Operating Temperature	T <sub>OP</sub>	-20 ~ 75	°C
Junction Temperature	T <sub>J</sub>	150	°C

Note: Unless any other command is noted, all above are operated in normal temperature.

## Electrical Characteristics

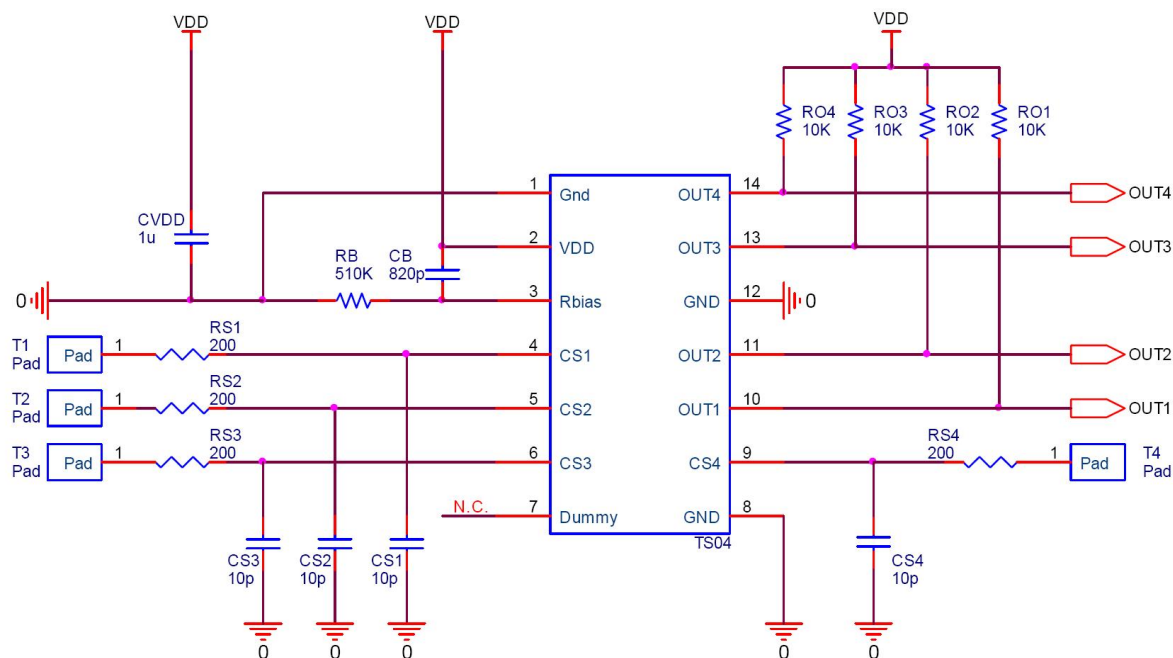
(Unless otherwise specified:  $T_A = 25^{\circ}\text{C}$ ,  $V_{DD}=3.3\text{V}$ ,  $R_B=510\text{k}$ )

Parameter Name	Symbol	Test Conditions	Min	Typ	Max	Units
Operating Supply Voltage	$V_{DD}$		2.5	3.3	5.0	V
Current Consumption	$I_{DD}$	$V_{DD}=3.3\text{V}, R_B=510\text{k}$		40	70	$\mu\text{A}$
		$V_{DD}=5.0\text{V}, R_B=510\text{k}$		80	140	
Digital Output Maximum Sink Current	$I_{OUT}$	$T_A = 25^{\circ}\text{C}$			4.0	mA
Internal Reset Criterion $V_{dd}$ Voltage	$V_{DD\_RST}$	$T_A = 25^{\circ}\text{C}$ , $R_B=510\text{k}$			$0.3 \cdot V_{DD}$	V
Sense Input Capacitance Range <b>(Note1)</b>	$C_S$				100	pF
Minimum Detective Capacitance Difference	$\Delta C$	$C_S=10\text{pF}$	0.2			pF
Output Impedance (Open Drain)	$Z_O$	$\Delta C > 0.2\text{pF}, C_S=10\text{pF}$		12		$\Omega$
		$\Delta C < 0.2\text{pF}, C_S=10\text{pF}$		30		$\text{M}\Omega$
Self Calibration Time After System Reset	$T_{CAL}$	$V_{DD}=3.3\text{V}, R_B=510\text{k}$		100		mS
		$V_{DD}=5.0\text{V}, R_B=510\text{k}$		80		
Sense Input Resistance Range	$R_S$			200	1000	$\Omega$
Recommended Bias Resistance Range <b>(Note 2)</b>	$R_B$	$V_{DD}=3.3\text{V}$	200	510	820	$\text{k}\Omega$
		$V_{DD}=5.0\text{V}$	330	620	1200	
Maximum Bias Capacitance	$C_{B\_MAX}$			820	1000	pF

**Note1** : The sensitivity can be increased with lower  $C_S$  value. The recommended value of  $C_S$  is 10pF when using 3T PC(Poly Carbonate) cover and 10 mm x 7mm touch pattern.

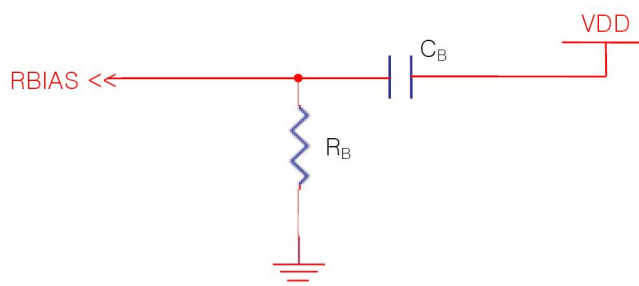
**Note2** : The lower  $R_B$  is recommended in noisy condition.

## Typical Application

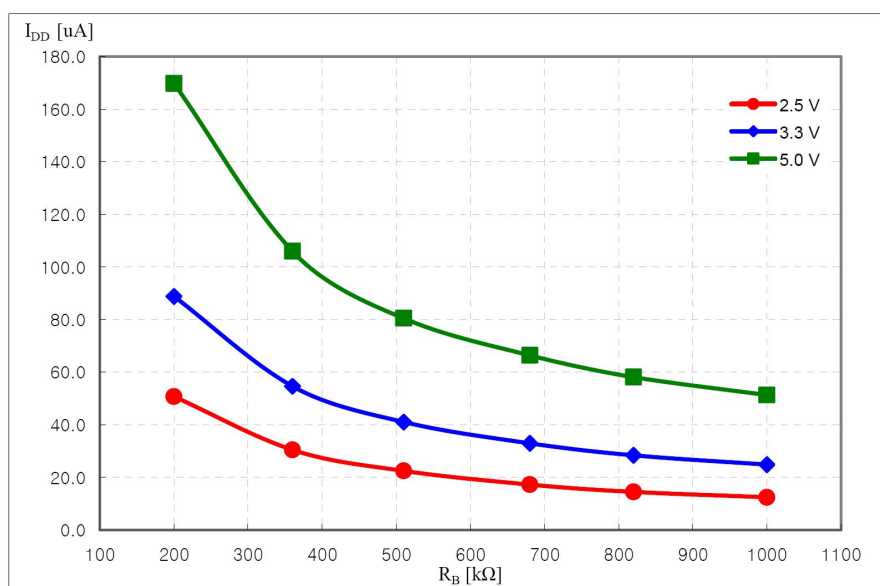


## Application Information

### RBIAS & SRBIAS implementation



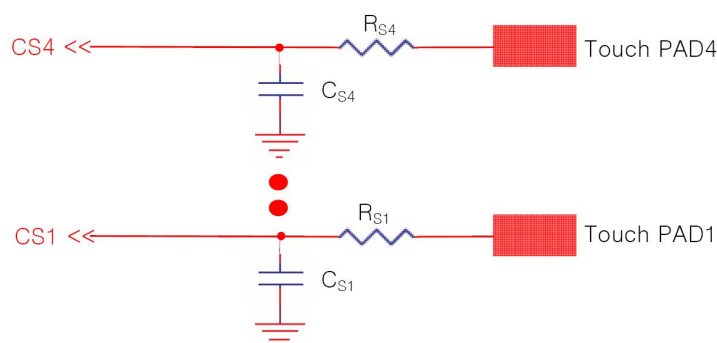
The RBIAS is connected the resistor to decide the oscillator and internal bias current. The sensing frequency, internal clock frequency and current consumption are therefore able to be adjusted with  $R_B$ . A voltage ripple on RBIAS can make critical internal error, so  $C_B$  is connected to the VDD (not GND) is recommended. (The typical value of  $C_B$  is 820pF and the maximum Value is 1nF.)



Normal operation current consumption curve

The current consumption curve of TS04 is represented in accordance with  $R_B$  value as above. The lower  $R_B$  requires more current consumption but it is recommended in noisy application. For example, refrigerator, air conditioner and so on.

## CS implementation



The TS04 has available sensing channel up to 4. The parallel capacitor  $CS_1$  is added to  $CS_1$  and  $CS_4$  to  $CS_4$  to adjust fine sensitivity. The sensitivity would increase when a smaller value of  $CS$  is used. (Refer to the below Sensitivity Example Figure) It could be useful in case detail sensitivity mediation is required. The internal touch decision process of each channel is separated from each other. The four channel touch key board application can therefore be designed by using only one TS04 without coupling problem. The  $RS$  is serial connection resistor to avoid malfunction from external surge and ESD. (It might be optional.) From  $200\Omega$  to  $1k\Omega$  is recommended for  $RS$ . The size and shape of PAD might have influence on the sensitivity. The sensitivity will be optimal when the size of PAD is approximately an half of the first knuckle (it's about  $10\text{ mm} \times 7\text{ mm}$ ).

The connection line of  $CS_1 \sim CS_4$  to touch PAD is recommended to be routed as short as possible to prevent

from abnormal touch detect caused by connection line.

There are some sensitivity difference among CS1, CS2 and CS3, and CS4 caused by internal parasitic capacitance. That sensitivity difference could be compensated by using different CS capacitor or sensitivity setting with internal register. To use different touch pattern area could be used for sensitivity compensation but not recommended. The sensitivity of each channel can be represented as below.

Sensitivity of CS1  $\geq$  Sensitivity of CS2, CS3  $>$  Sensitivity of CS4

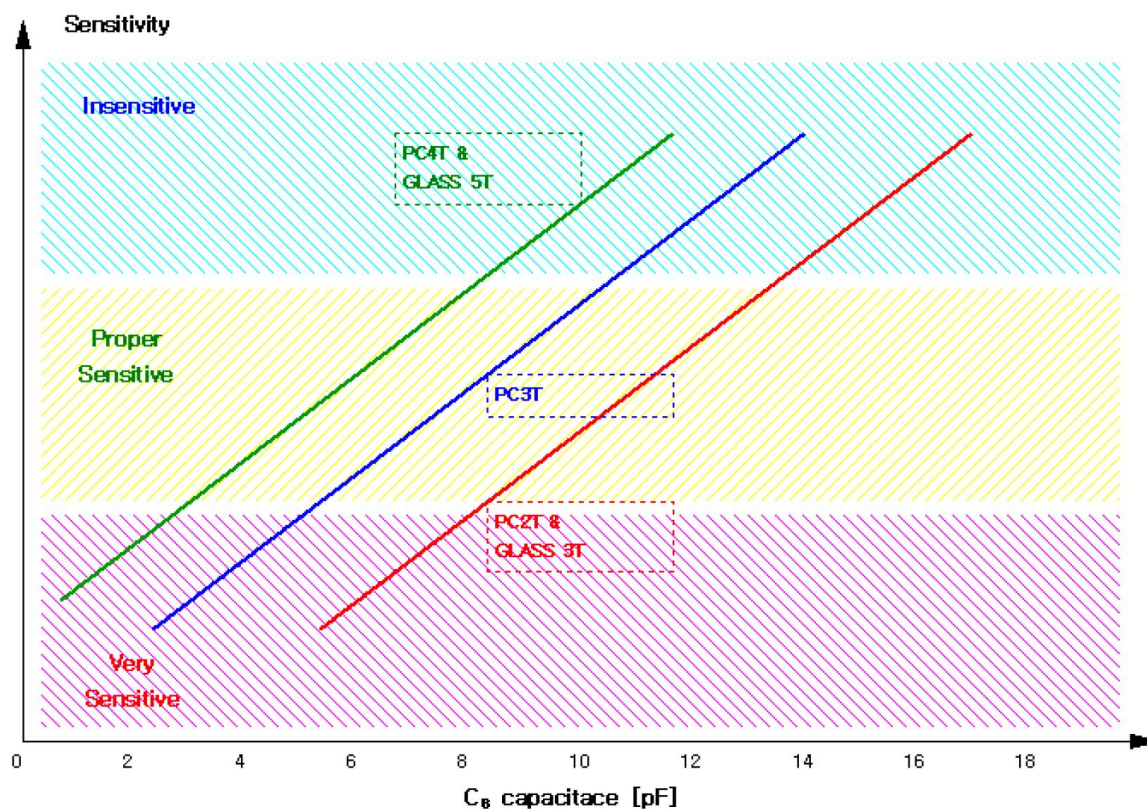
(In case of the external parasitic capacitance value is same on each channel.)

$$C_{CS1\_PARA} + \text{about } 3.5\text{pF} = C_{CS2,3\_PARA} + \text{about } 3\text{pF} = C_{CS4\_PARA}$$

\*  $C_{CS1\_PARA}$  : Parasitic capacitance of CS1

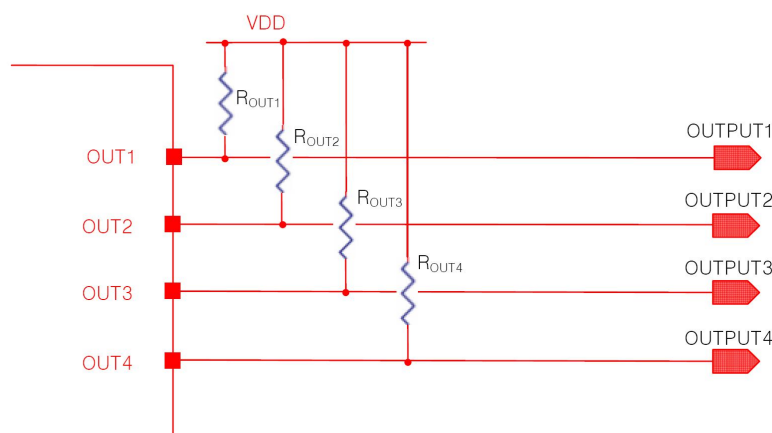
\*  $C_{CS2,3\_PARA}$  : Parasitic capacitance of CS2 and CS3

\*  $C_{CS4\_PARA}$  : Parasitic capacitance of CS4



Sensitivity example figure with default sensitivity selection

## Output Circuit Implementation



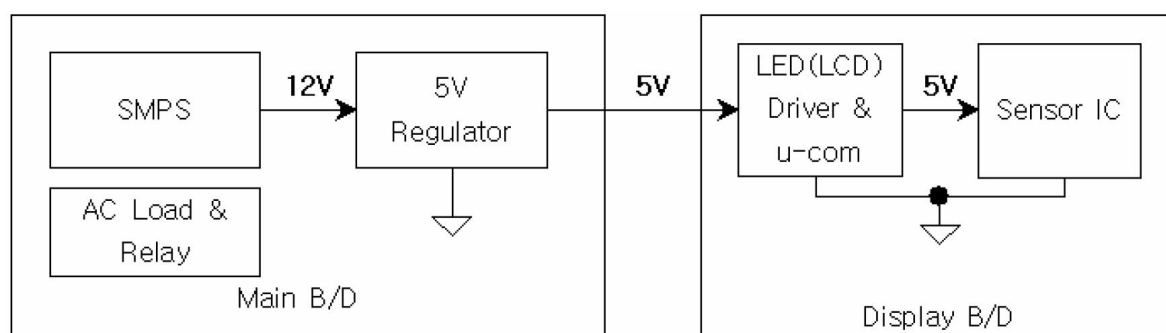
The OUTPUT pins have an open drain structure. For this reason, the connection of pull-up resistor  $R_{OUT}$  is required between OUTPUT and VDD. The maximum output sink current is 4mA, so over a few  $k\Omega$  must be used as  $R_{OUT}$ . Normally 10k $\Omega$  is used as  $R_{OUT}$ . The OUTPUT is high in normal situation, and the value is low when a touch is detected on the corresponding CS.

## Internal reset operation

The TS04 has stable internal reset circuit to offer reset pulse to digital block. The supply voltage for a system start or restart should be under 0.3·VDD of normal operation VDD. No external components required for TS04 power reset, that helps simple circuit design and to realize the low cost application.

## Example – Power Line Split Strategy PCB Layout

### A. Not split power line (Bad power line design)

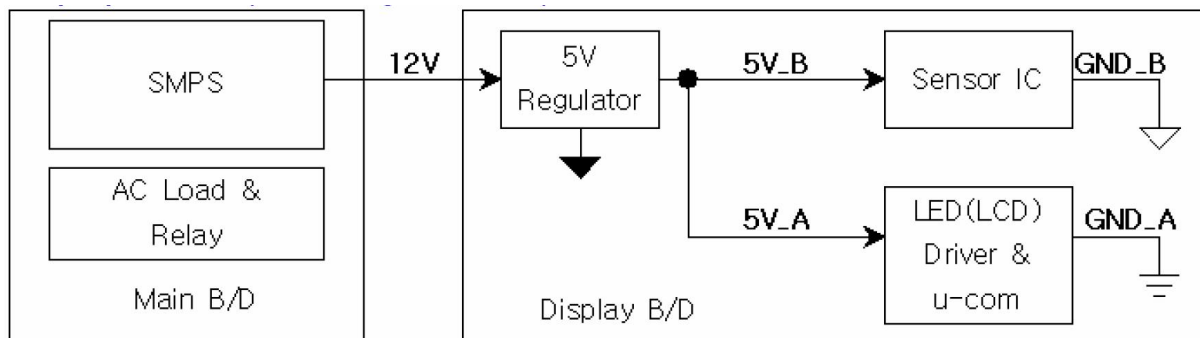


\*The noise that is generated by AC load or relay can be loaded at 5V power line.

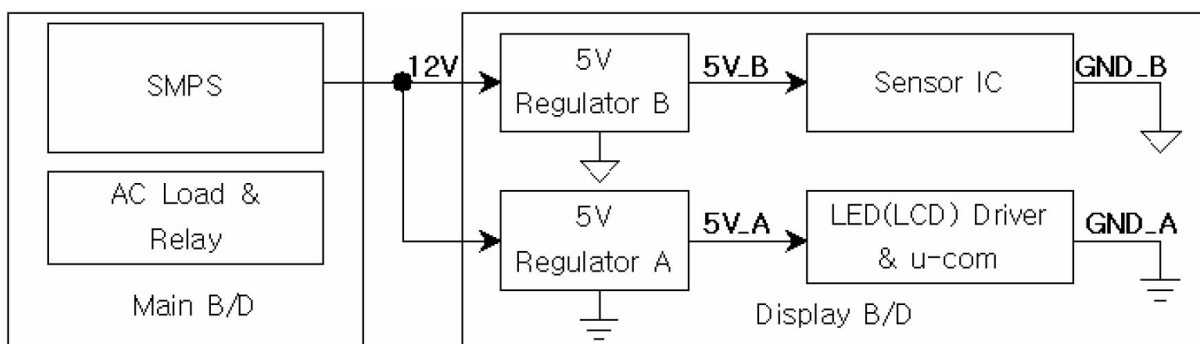
\*A big inductance might be appeared in case of the connection line between main board and display board is too long, moreover the voltage ripple could be generated by LED (LCD) display driver at VDD (5V).



## B. Split power line (One 5V regulator used) – Recommended



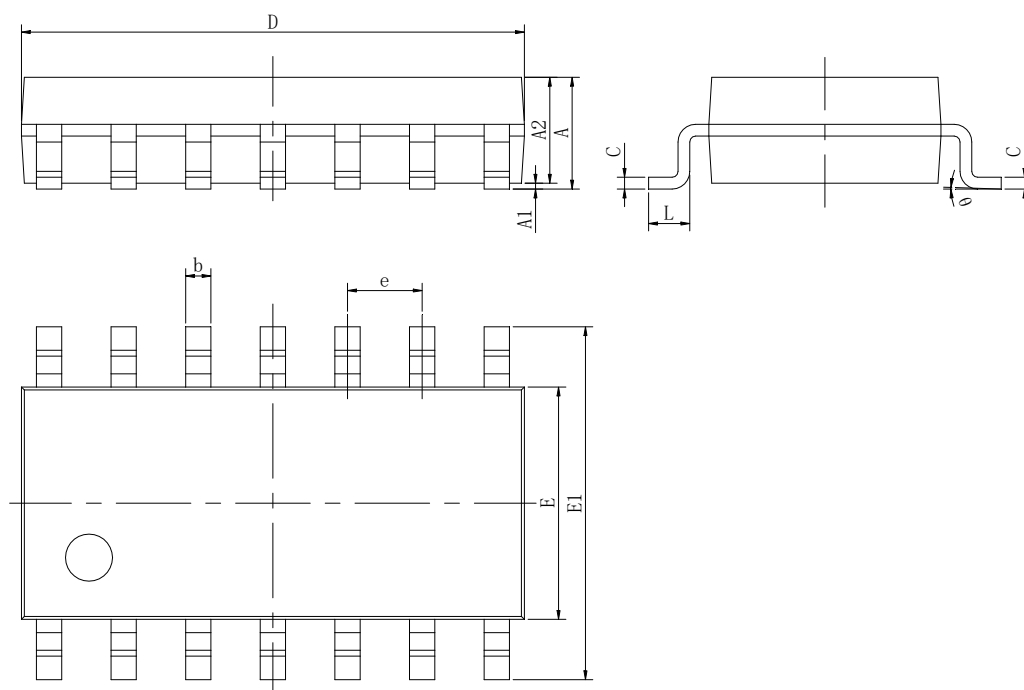
## C. Split power line (Separated 5V regulator used) – Strongly recommended



## Outline Dimensions

SOP14

Unit:mm



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	8.360	8.760	0.329	0.345
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

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